

# **1.5A, Step Down Switching Regulator**

## **General Description**

The ASD34063 Series is a monolithic control circuit containing the primary functions required for DC-to-DC converters. These devices consist of an internal temperature compensated reference, comparator, controlled duty cycle oscillator With an active current limit circuit, driver and high current output switch. This series of devices were specifically designed to be incorporated in Step-Down, Step-Up, and Voltage-Inverting applications with a minimum number of external components.

## **Features**

- V<sub>IN</sub> range: 3.0 40V
- Low standby current
- Output switch current up to 1.5A
- Adjustable output voltage
- Programmable switching frequency
- Excellent load regulation
- Current limit protection
- Thermal shutdown protection
- -40°C to +85°C temperature range
- Available in SOIC-8 package

## **Applications**

- Point of load
- Consumer
- Industrial

## **Typical Application**





#### **Pin Description**

Pin #	Description		
1	Switch Collector node		
2	Switch Emitter node		
3	Timing Cap		
4	Ground		
5	Feedback pin.		
6	Input supply voltage.		
7	Current sense		
8	Driver collector		

#### **Pin Configuration**

(Top View)





#### Absolute Maximum Ratings<sup>(1)</sup>

Maximum Input Supply Voltage	-0.3V to 40V
Feedback Voltage (FB)	-0.3V to 40V
Switch Collector Voltage	-0.3V to 40V
Switch Emitter Voltage	-0.3V to 40V
Driver Collector Voltage	-0.3V to 40V
Driver Collector Current	100mA
Switch Current	. 1.5A

#### **Recommended Operating Conditions**

Input Voltage	
Ambient Operating Temperature	-40°C to +85°C

#### **Thermal Information** <sup>(2)</sup>

SOIC-8	θ.ιΑ	100°C/W
Storage 7	Temperature Range	65 to 150°C
Junction .	Temperature	+150°C

## **Electrical Characteristics**

UNLESS OTHERWISE NOTED: VIN=12V;VOUT=5V; TYPICAL VALUES ARE TA= 25°C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Switching frequency	F <sub>osc</sub>	V <sub>FB</sub> =GND; C <sub>T</sub> =1.0nF	24	33	42	kHz
Charging current	I <sub>CHG</sub>	V <sub>IN</sub> =5V - 40V	24	33	42	μA
Discharge current	I <sub>DISCHG</sub>	V <sub>IN</sub> =5V - 40V	140	220	260	μA
Discharge to charge current ratio	I <sub>DISCHG</sub> / I <sub>CHG</sub>	I <sub>PK</sub> =V <sub>IN</sub>	5.2	6.5	7.5	-
Current sense voltage	V <sub>IPK(SENSE)</sub>	I <sub>DISCHG</sub> = I <sub>CHG</sub>	250	300	350	mV
Saturation Voltage	V <sub>CE(SAT)</sub>	I <sub>OUT</sub> =1.0A		1.0	1.3	V
Saturation Voltage	V <sub>CE(SAT)</sub>	$I_{OUT}$ =1.0 A, Rpin8 =82 $\Omega$ to V <sub>IN</sub> , Forced $\beta$ = 20		0.45	0.7	V
DC current gain	h <sub>FE</sub>	I <sub>OUT</sub> =1.0 A, VCE = 5.0	50	75		
Collector off state current	I <sub>C(off)</sub>	V <sub>CE</sub> =40V		40	100	μA
Feedback Voltage	V <sub>FB</sub>		1.225	1.25	1.275	V
Line regulation		V <sub>IN</sub> =3V - 40V		1.4	5.0	mV
Feedback input bias current	I <sub>FB</sub>			-20	-400	nA
Supply current	I <sub>IN</sub>	$V_{IN}$ = 5.0 - 40V, $C_T$ =1.0 nF, Pin7= $V_{IN}$ pin 5> $V_{FB}$ , Pin 2 = GND, remaining pins open			4.0	mA

Notes:

1. Stresses above those listed in Absolute Maximum Ratings may cause permanent damage to the device.

2. Measured on approximately 1" square of 1oz copper

3. The ASD34063 is guaranteed to meet performance specifications over the -40°C to +125°C operating temperature range and is assured by design, characterization, and correlation with statistical process control.

4. Low duty cycle pulse testing with Kelvin connection required.



## **Ordering Information**

Device	Package	Output Voltage	Packing Method & Quantity
ASD34063M8	SOIC-8	Adj	2500 Tape & Reel

### **Outline Drawing and Landing Pattern – SOIC-8**



0. mb a l	Dimensions In Millimeters		Dimensions In Inches	
Symbol	Min	Max	Min	Max
Α	1.350	1, 750	0.053	0.069
A1	0.100	0. 250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
с	0.170	0.250	0.006	0.010
D	4. 700	5. 100	0. 185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6. 200	0. 228	0.244
е	1.270	(BSC)	0.050	(BSC)
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

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